

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced super junction technology and design to provide excellent RDS(ON) with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

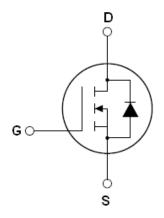
F	Δa	tu	res
	60	LU	163

- New technology for high voltage device
- ●Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS}	650	V
R _{DS(ON)} TYP.	36	mΩ
I_D	75	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking	
NCE65TF041T	TO-247	NCE65TF041T	



TO-247

Table 1. Absolute Maximum Ratings ($T_c=25^{\circ}$ C)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage (VDS=0V) AC (f>1 Hz)	V _{GS}	±30	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	75	Α
Continuous Drain Current at Tc=100°C	I _{D (DC)}	47	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	300	А
Maximum Power Dissipation(Tc=25℃)	P_{D}	510	W
Derate above 25°C		4.08	W/°C
Single pulse avalanche energy (Note 2)	Eas	1936	mJ
Avalanche current ^(Note 1)	I _{AR}	28	Α
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	2.5	mJ



Parameter	Symbol	Value	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \le 480 \text{ V,I}_{SD} < I_D$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55+150	°C

^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	0.245	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
On/off states	1					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =500μA	650			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			5	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			500	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =500μA	2.5	3.5	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =38A		36	41	mΩ
Dynamic Characteristics						
Input Capacitance	C _{Iss}	V _{DS} =100V,V _{GS} =0V,		7300	8500	PF
Output Capacitance	Coss	F=1.0MHz		252		PF
Reverse Transfer Capacitance	C _{rss}	Γ-1.UIVIΠZ		4		PF
Total Gate Charge	Qg	\/ -490\/ -754		116	135	nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =75A, V _{GS} =10V		40		nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V		30		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			27		nS
Turn-on Rise Time	t _r	V_{DD} =380 V , I_{D} =38 A ,		22		nS
Turn-Off Delay Time	t _{d(off)}	R_G =1.2 Ω , V_{GS} =10 V		118	180	nS
Turn-Off Fall Time	t _f			13	30	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25°C		75		Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	1 _C -25 C		300		Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =75A,V _{GS} =0V		1.3		٧
Reverse Recovery Time	t _{rr}	T:-25°C -20 \ di/dt-100 \ /		230		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =38A,di/dt=100A/μs V _{DD} =300V		3		uC
Peak Reverse Recovery Current	I _{rrm}	V DD-300 V		26		Α

 $Notes\ 1. \\ \textit{Repetitive Rating: Pulse width limited by maximum junction temperature}$

^{2.} Tj=25°C,VDD=50V,VG=10V, R_G =25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe Operating Area

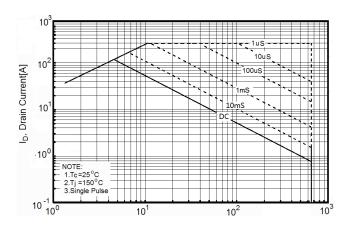


Figure 3. Source-Drain Diode Forward Voltage

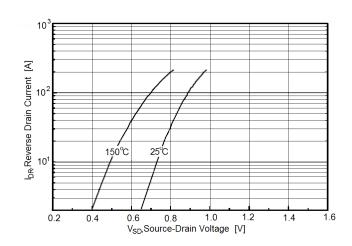


Figure 4. Output Characteristics

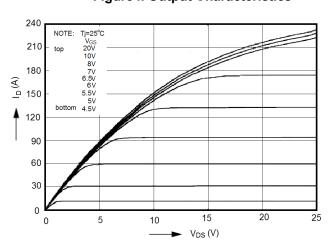


Figure 5. Transfer Characteristics

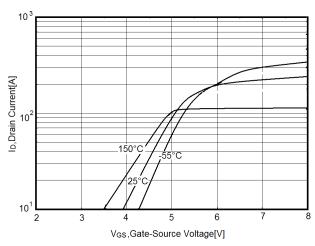


Figure 6. Static drain-source on resistance

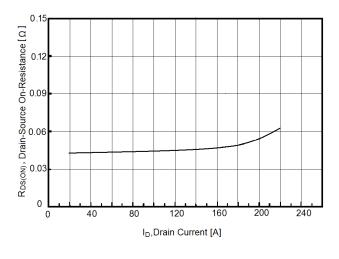


Figure 7. R_{DS(ON)} vs Junction Temperature

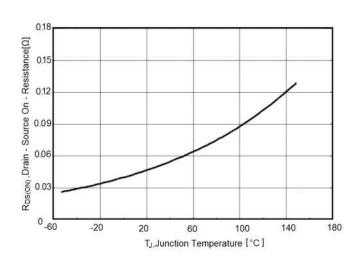




Figure 8. BV_{DSS} vs Junction Temperature

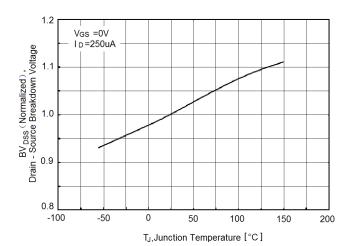
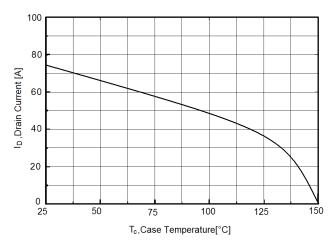


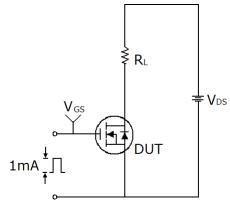
Figure 9. Maximum I_D vs Junction Temperature

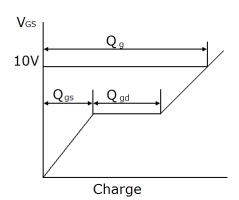




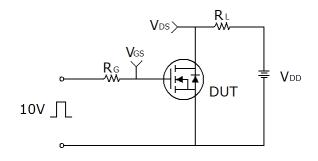
Test circuit

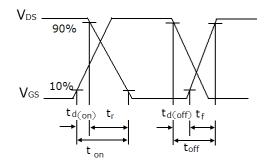
1) Gate charge test circuit & Waveform



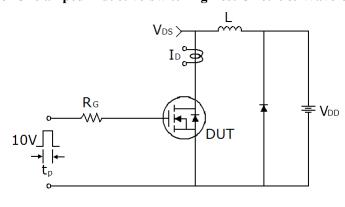


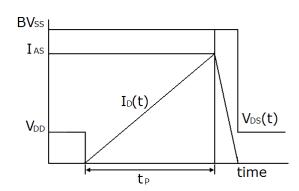
2) Switch Time Test Circuit:





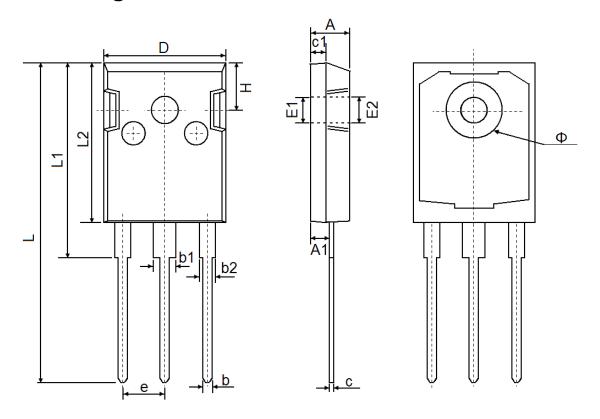
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-247 Package Information



0	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.50	3.500 REF 0.138 REF		REF	
E2	3.60	0 REF	0.142 REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Ф	7.100	7.300	0.280	0.287	
е	5.450 TYP		0.215 TYP		
Н	5.980 REF		0.235 REF		



ATTENTION:

- Any and all NCE products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE representative nearest you before using any NCE products described or contained herein in such applications.
- NCE assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE products described or contained herein.
- Specifications of any and all NCE products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE Power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE Power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE product that you intend to use.
- This catalog provides information as of Mar. 2010. Specifications and information herein are subject to change without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by NCE Power manufacturer:

Other Similar products are found below:

614233C 648584F MCH3443-TL-E MCH6422-TL-E FDPF9N50NZ FW216A-TL-2W FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E FCA20N60_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T) D2294UK 405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G 614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3